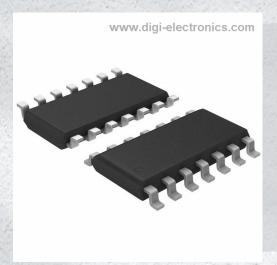


UA723CD Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number UA723CD-DG

Manufacturer Texas Instruments

Manufacturer Product Number UA723CD

Description IC REG LIN POS ADJ 150MA 14SOIC

Detailed Description Linear Voltage Regulator IC Positive Adjustable 1 O

utput 150mA 14-SOIC



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
UA723CD	Texas Instruments
Series:	Product Status:
	Active
Output Configuration:	Output Type:
Positive	Adjustable
Number of Regulators:	Voltage - Input (Max):
1	40V
Voltage - Output (Min/Fixed):	Voltage - Output (Max):
2V	37V
Voltage Dropout (Max):	Current - Output:
	150mA
PSRR:	Control Features:
74dB ~ 86dB (50Hz ~ 10kHz)	Current Limit
Protection Features:	Operating Temperature:
	0°C ~ 70°C
Mounting Type:	Package / Case:
Surface Mount	14-SOIC (0.154", 3.90mm Width)
Supplier Device Package:	Base Product Number:
14-SOIC	UA723

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTCHC.	

8542.39.0001

D OR N PACKAGE (TOP VIEW)

NC

IN- Π 4

IN+ [

REF

V_{CC}-

CURR LIM [

CURR SENS [] 3

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П NC 14

12 [] V_{CC+}

9 🛛 V_Z 8 NC

11

10

13 | FREQ COMP

NOUTPUT

- 150-mA Load Current Without External **Power Transistor**
- **Adjustable Current-Limiting Capability**
- Input Voltages up to 40 V
- Output Adjustable From 2 V to 37 V
- Direct Replacement for Fairchild µA723C

description

The µA723 is a precision integrated-circuit voltage regulator, featuring high ripple rejection,

excellent input and load regulation, excellent temperature stability, and low standby current. The circuit consists of a temperature-compensated reference-voltage amplifier, an error amplifier, a 150-mA output transistor, and an adjustable-output current limiter.

The μA723 is designed for use in positive or negative power supplies as a series, shunt, switching, or floating regulator. For output currents exceeding 150 mA, additional pass elements can be connected as shown in Figures 4 and 5.

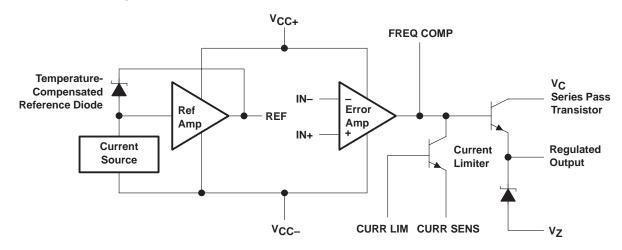
The μA723C is characterized for operation from 0°C to 70°C.

AVAILABLE OPTIONS

	PACKAGE	CHIP	
TA	PLASTIC DIP (N)	SMALL OUTLINE (D)	FORM (Y)
0°C to 70°C	μΑ723CN	μΑ723CD	μΑ723Υ

The D package is available taped and reeled. Add the suffix R to the device type (e.g., µA723CDR). Chip forms are tested at 25°C.

functional block diagram

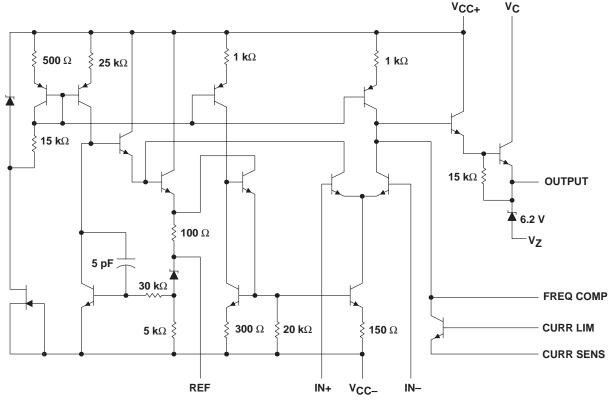




Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



schematic



Resistor and capacitor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Peak voltage from V_{CC+} to V_{CC-} ($t_w \le 50$ ms)	50 V
Continuous voltage from V _{CC+} to V _{CC-}	40 V
Input-to-output voltage differential	
Differential input voltage to error amplifier	$\dots \dots \pm 5 \ V$
Voltage between noninverting input and V _{CC}	8 V
Current from V _Z	25 mA
Current from REF	15 mA
Package thermal impedance, θ_{JA} (see Notes 1 and 2): D package	86°C/W
N package	101°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D or N package	260°C
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can impact reliability.
 - 2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.



PRECISION VOLTAGE REGULATORS

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recommended operating conditions

		MIN	MAX	UNIT
Input voltage, V _I		9.5	40	V
Output voltage, VO		2	37	V
Input-to-output voltage differential, V _C – V _O		3	38	V
Output current, I _O			150	mA
Operating free-air temperature range, TA	μΑ723C	0	70	°C

electrical characteristics at specified free-air temperature (see Notes 3 and 4)

PARAMETER	TEST CONDIT	TONE	_		UNIT			
PARAMETER	TEST CONDIT	IONS	TA	MIN	TYP	MAX	ONT	
	$V_{ } = 12 \text{ V to } V_{ } = 15 \text{ V}$		25°C		0.1	1		
Input regulation	$V_{I} = 12 \text{ V to } V_{I} = 40 \text{ V}$		25°C		1	5	mV/V	
	$V_{ } = 12 \text{ V to } V_{ } = 15 \text{ V}$		0°C to 70°C			3		
Ripple rejection	f = 50 Hz to 10 kHz,	$C_{ref} = 0$	25°C		74		dB	
Rippie rejection	f = 50 Hz to 10 kHz,	C _{ref} = 5 μF	25°C		86		uБ	
Output regulation			25°C		-0.3	-2	mV/V	
Output regulation			0°C to 70°C			-6	IIIV/V	
Reference voltage, V _{ref}			25°C	6.8	7.15	7.5	V	
Standby current	V _I = 30 V,	I _O = 0	25°C		2.3	4	mA	
Temperature coefficient of output voltage			0°C to 70°C		0.003	0.015	%/°C	
Short-circuit output current	$R_{SC} = 10 \Omega$,	VO = 0	25°C		65		mA	
Output poins voltage	BW = 100 Hz to 10 kHz,	C _{ref} = 0	25°C		20		\/	
Output noise voltage	BW = 100 Hz to 10 kHz,	C _{ref} = 5 μF	25°C		2.5		μV	

NOTES: 3. For all values in this table, the device is connected as shown in Figure 1 with the divider resistance as seen by the error amplifier \leq 10 k Ω . Unless otherwise specified, V_I = V_{CC+} = V_C = 12 V, V_{CC-} = 0, V_O = 5 V, I_O = 1 mA, R_{SC} = 0, and C_{ref} = 0.

4. Pulse-testing techniques must be used that will maintain the junction temperature as close to the ambient temperature as possible.

electrical characteristics, T_A = 25°C (see Notes 3 and 4)

DADAMETER	TEST CONDI	Ļ	UNIT			
PARAMETER	TEST CONDIT	TEST CONDITIONS				
Input regulation	V _I = 12 V to V _I = 15 V			0.1		mV/V
Imput regulation	$V_{I} = 12 \text{ V to } V_{I} = 40 \text{ V}$			1		111 V / V
Pipple rejection	f = 50 Hz to 10 kHz,	C _{ref} = 0		74		dB
Ripple rejection	f = 50 Hz to 10 kHz,	C _{ref} = 5 μF	86			l ub
Output regulation				-0.3		mV/V
Reference voltage, V _{ref}				7.15		V
Standby current	V _I = 30 V,	IO = 0		2.3		mA
Short-circuit output current	$R_{SC} = 10 \Omega$,	V _O = 0		65		mA
Output noise voltage	BW = 100 Hz to 10 kHz,	C _{ref} = 0		20		μV
Output hoise voltage	BW = 100 Hz to 10 kHz,	C _{ref} = 5 μF		2.5		μν

NOTES: 3. For all values in this table, the device is connected as shown in Figure 1 with the divider resistance as seen by the error amplifier \leq 10 k Ω . Unless otherwise specified, V_I = V_{CC+} = V_C = 12 V, V_{CC-} = 0, V_O = 5 V, I_O = 1 mA, R_{SC} = 0, and C_{ref} = 0.

4. Pulse-testing techniques must be used that will maintain the junction temperature as close to the ambient temperature as possible.



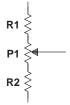
APPLICATION INFORMATION

Table 1. Resistor Values ($k\Omega$) for Standard Output Voltages

OUTPUT VOLTAGE	APPLICABLE FIGURES	FIXED C		OUTPUT ADJUSTABLE ±10% (SEE NOTE 6)				
(V)	(SEE NOTE 5)	R1 (kΩ)	R2 (kΩ)	R1 (kΩ)	P1 (kΩ)	P2 (kΩ)		
3.0	1, 5, 6, 9, 11, 12 (4)	4.12	3.01	1.8	0.5	1.2		
3.6	1, 5, 6, 9, 11, 12 (4)	3.57	3.65	1.5	0.5	1.5		
5.0	1, 5, 6, 9, 11, 12 (4)	2.15	4.99	0.75	0.5	2.2		
6.0	1, 5, 6, 9, 11, 12 (4)	1.15	6.04	0.5	0.5	2.7		
9.0	2, 4, (5, 6, 9, 12)	1.87	7.15	0.75	1.0	2.7		
12	2, 4, (5, 6, 9, 12)	4.87	7.15	2.0	1.0	3.0		
15	2, 4, (5, 6, 9, 12)	7.87	7.15	3.3	1.0	3.0		
28	2, 4, (5, 6, 9, 12)	21.0	7.15	5.6	1.0	2.0		
45	7	3.57	48.7	2.2	10	39		
75	7	3.57	78.7	2.2	10	68		
100	7	3.57	105	2.2	10	91		
250	7	3.57	255	2.2	10	240		
-6 (see Note 7)	3, 10	3.57	2.43	1.2	0.5	0.75		
-9	3, 10	3.48	5.36	1.2	0.5	2.0		
-12	3, 10	3.57	8.45	1.2	0.5	3.3		
-15	3, 10	3.57	11.5	1.2	0.5	4.3		
-28	3, 10	3.57	24.3	1.2	0.5	10		
-45	8	3.57	41.2	2.2	10	33		
-100	8	3.57	95.3	2.2	10	91		
-250	8	3.57	249	2.2	10	240		

NOTES: 5. The R1/R2 divider can be across either V_O or V_(ref). If the divider is across V_(ref), use the figure numbers without parentheses. If the divider is across V_O use the figure numbers in parentheses

VO, use the figure numbers in parentheses.
To make the voltage adjustable, the R1/R2 divider shown in the figures must be replaced by the divider shown below.



Adjustable Output Circuit

7. For Figures 3, 8, and 10, the device requires a minimum of 9 V between V_{CC+} and V_{CC-} when V_O is equal to or more positive than -9 V.

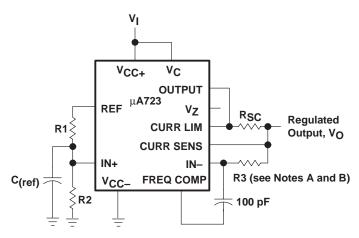


APPLICATION INFORMATION

Table 2. Formulas for Intermediate Output Voltages

OUTPUTS FROM 2 V TO 7 V SEE FIGURES 1, 5, 6, 9, 11, 12 (4) AND NOTE 5	OUTPUTS FROM 4 V TO 250 V SEE FIGURE 7 AND NOTE 5	CURRENT LIMITING			
$V_{O} = V_{(ref)} \times \frac{R2}{R1 + R2}$	$V_{O} = \frac{V_{(ref)}}{2} \times \frac{R2 - R1}{R1}$ R3 = R4	$I_{(limit)} \approx \frac{0.65 \text{ V}}{R_{SC}}$			
OUTPUTS FROM 7 V TO 37 V SEE FIGURES 2, 4, (5, 6, 9, 11, 12) AND NOTE 5	OUTPUTS FROM -6 V TO -250 V SEE FIGURES 3, 8, 10 AND NOTES 5 AND 7	FOLDBACK CURRENT LIMITING SEE FIGURE 6			
$V_{O} = V_{(ref)} \times \frac{R1 + R2}{R2}$	$V_{O} = -\frac{V_{(ref)}}{2} \times \frac{R1 + R2}{R1}$ $R3 = R4$	$\begin{split} & I_{(knee)} \approx \frac{V_{O}R3 + (R3 + R4) \ 0.65 \ V}{R_{SC}R4} \\ & I_{OS} \approx \frac{0.65 \ V}{R_{SC}} \ \times \frac{R3 + R4}{R4} \end{split}$			

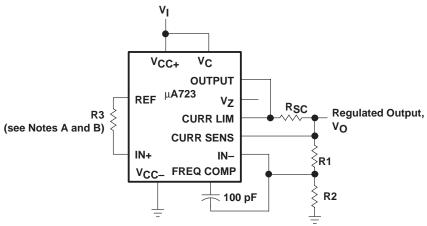
- NOTES: 5. The R1/R2 divider can be across either VO or V(ref). If the divider is across V(ref), use figure numbers without parentheses. If the divider is across V_O, use the figure numbers in parentheses.
 - 7. For Figures 3, 8, and 10, the device requires a minimum of 9 V between V_{CC+} and V_{CC-} when V_O is equal to or more positive than



NOTES: A. R3 = $\frac{R1 \times R2}{R1 + R2}$ for a minimum α_{V_0} B. R3 can be eliminated for minimum component count. Use direct connection (i.e., R₃ = 0).

Figure 1. Basic Low-Voltage Regulator ($V_0 = 2 V \text{ to } 7 V$)

APPLICATION INFORMATION



NOTES: A. R3 = $\frac{R1 \times R2}{R1 + R2}$ for a minimum α_{V_O} B. R3 can be eliminated for minimum component count. Use direct connection (i.e., R₃ = 0).

Figure 2. Basic High-Voltage Regulator ($V_0 = 7 \text{ V to } 37 \text{ V}$)

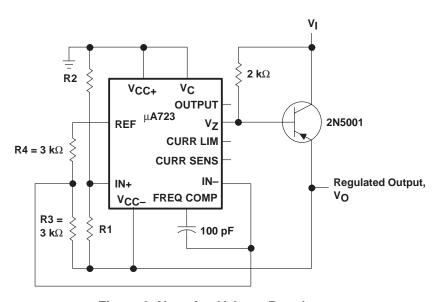


Figure 3. Negative-Voltage Regulator

APPLICATION INFORMATION

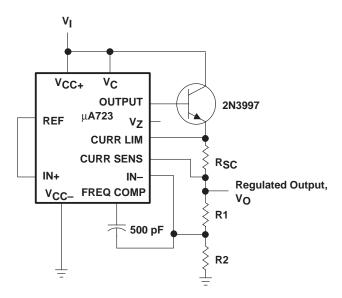


Figure 4. Positive-Voltage Regulator (External npn Pass Transistor)

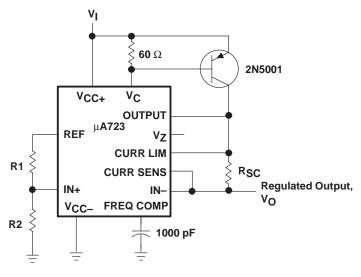


Figure 5. Positive-Voltage Regulator (External pnp Pass Transistor)

APPLICATION INFORMATION

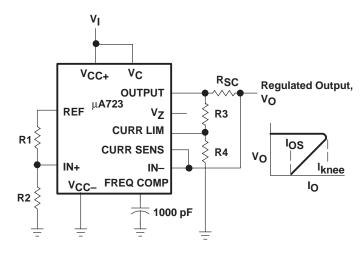


Figure 6. Foldback Current Limiting

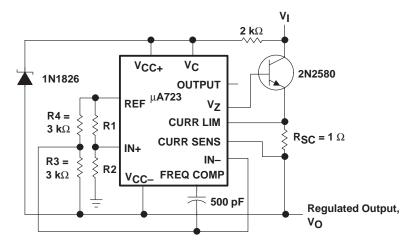


Figure 7. Positive Floating Regulator

PRECISION VOLTAGE REGULATORS

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APPLICATION INFORMATION

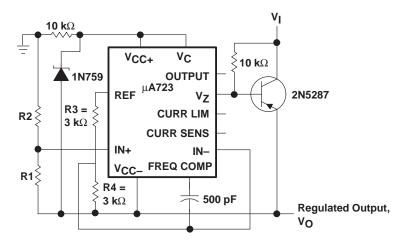
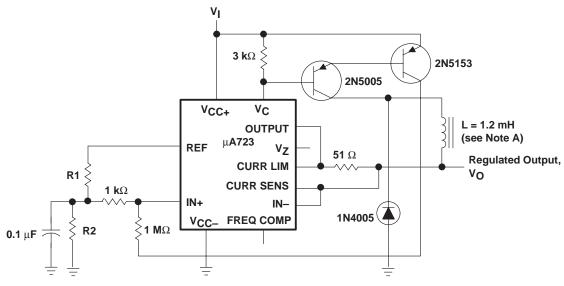


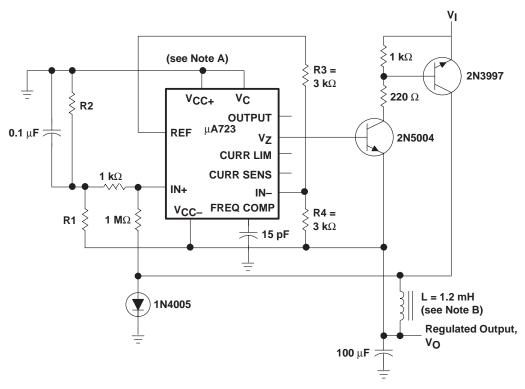
Figure 8. Negative Floating Regulator



NOTE A: L is 40 turns of No. 20 enameled copper wire wound on Ferroxcube P36/22-3B7 potted core, or equivalent, with a 0.009-inch air gap.

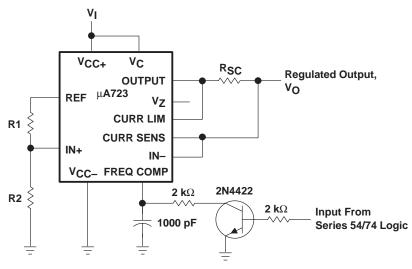
Figure 9. Positive Switching Regulator

APPLICATION INFORMATION



- NOTES: A. The device requires a minimum of 9 V between V_{CC+} and V_{CC-} when V_O is equal to or more positive than -9 V.
 - B. L is 40 turns of No. 20 enameled copper wire wound on Ferroxcube P36/22-3B7 potted core, or equivalent, with a 0.009-inch air gap.

Figure 10. Negative Switching Regulator



NOTE A: A current-limiting transistor can be used for shutdown if current limiting is not required.

Figure 11. Remote Shutdown Regulator With Current Limiting



PRECISION VOLTAGE REGULATORS

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APPLICATION INFORMATION

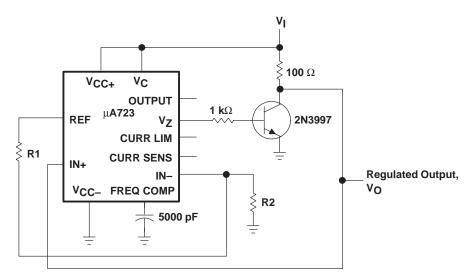


Figure 12. Shunt Regulator



PACKAGE OPTION ADDENDUM

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PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
UA723CD	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	UA723C	Samples
UA723CDE4	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	UA723C	Samples
UA723CDR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	UA723C	Samples
UA723CDRE4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	UA723C	Samples
UA723CDRG4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	UA723C	Samples
UA723CN	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	UA723CN	Samples
UA723CNE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	UA723CN	Samples
UA723CNSR	ACTIVE	SOP	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	UA723	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.





PACKAGE OPTION ADDENDUM

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(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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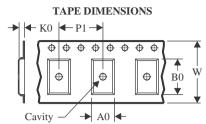


PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



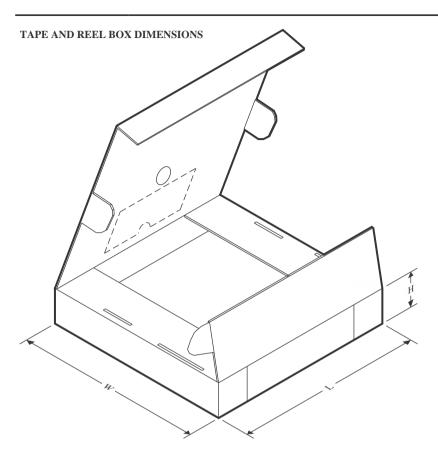
*All dimensions are nominal

	Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
I	UA723CDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
	UA723CNSR	SOP	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
UA723CDR	SOIC	D	14	2500	356.0	356.0	35.0
UA723CNSR	SOP	NS	14	2000	356.0	356.0	35.0



PACKAGE MATERIALS INFORMATION

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TUBE



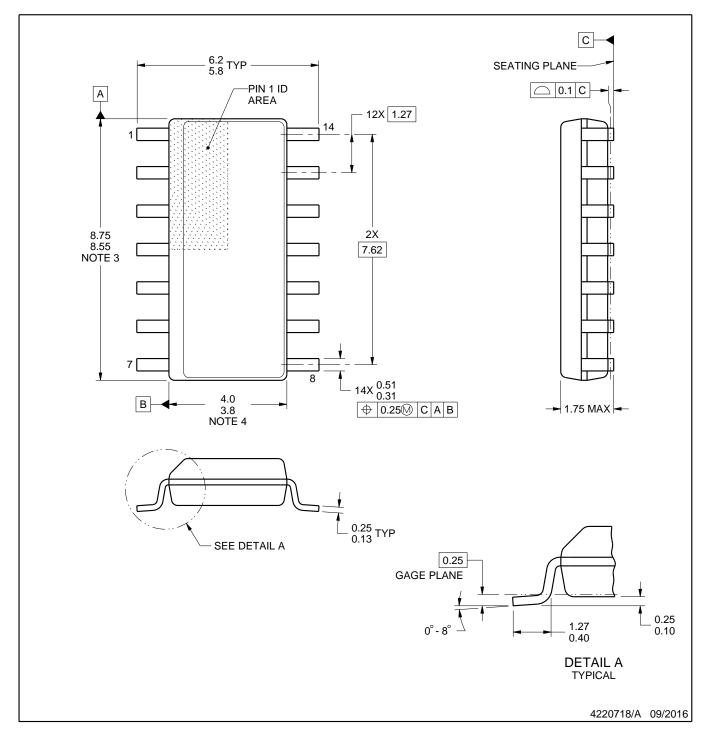
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
UA723CD	D	SOIC	14	50	506.6	8	3940	4.32
UA723CDE4	D	SOIC	14	50	506.6	8	3940	4.32
UA723CN	N	PDIP	14	25	506	13.97	11230	4.32
UA723CNE4	N	PDIP	14	25	506	13.97	11230	4.32

PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

D0014A

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

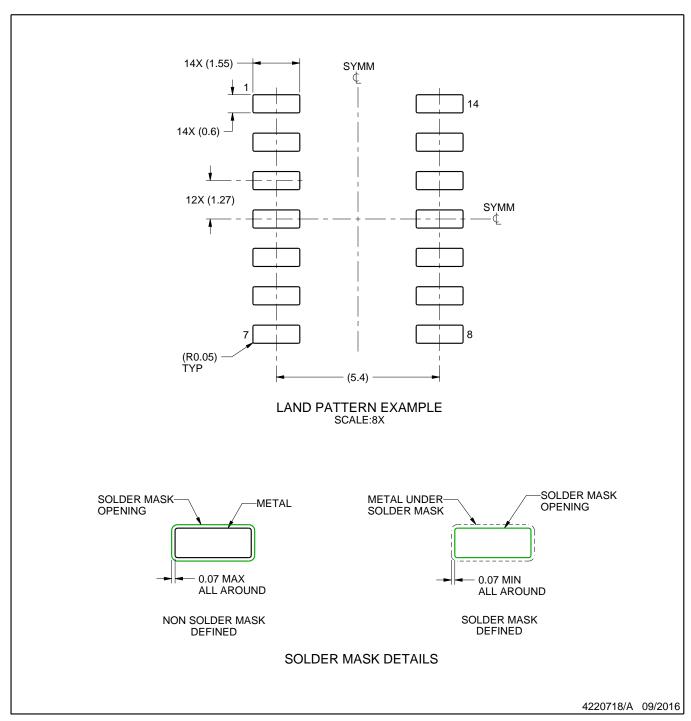
 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
- 5. Reference JEDEC registration MS-012, variation AB.



SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.

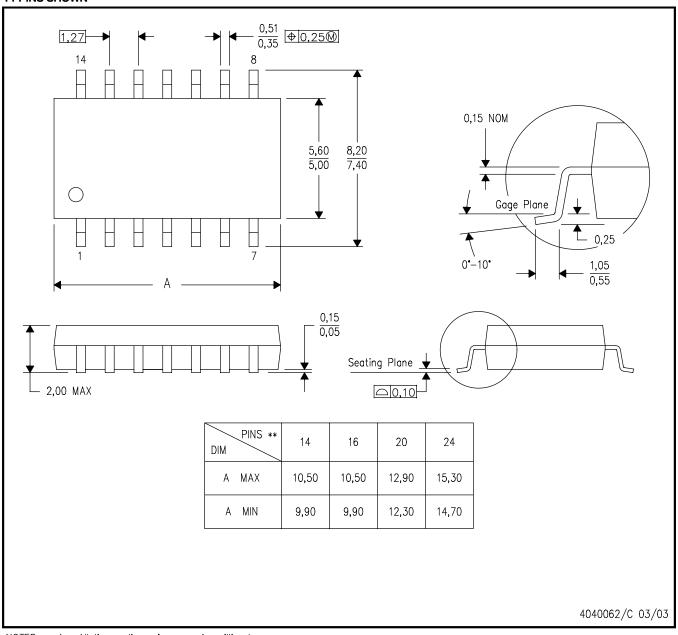


MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



MECHANICAL DATA

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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